

Click [here](#) for the 3D model.

Dimensions

D	7.34mm +0.41/-0.38mm
L	17.42mm +/-0.79mm
L2	20.88mm MAX
LL	38.1mm +/-6.35mm
F	0.64mm +/-0.05mm

Packaging Specifications

Packaging	Tray
Packaging Quantity	20

General Information

Series	T551
Dielectric	Polymer Tantalum
Style	Axial Hermetic
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov
SCIP Number	25028bfc-e2dd-4865-8096-81457a62194a
Termination	Solder Coated
Lead	Wire Leads
AEC-Q200	No
Construction	Hermetic
Component Weight	3.63 g
Miscellaneous	Sleeved.
Notes	Dimensions Include Insulating Sleeve. When supplied on T&R or AMMO, lead length is determined by taping specification.
Shelf Life	156 Weeks

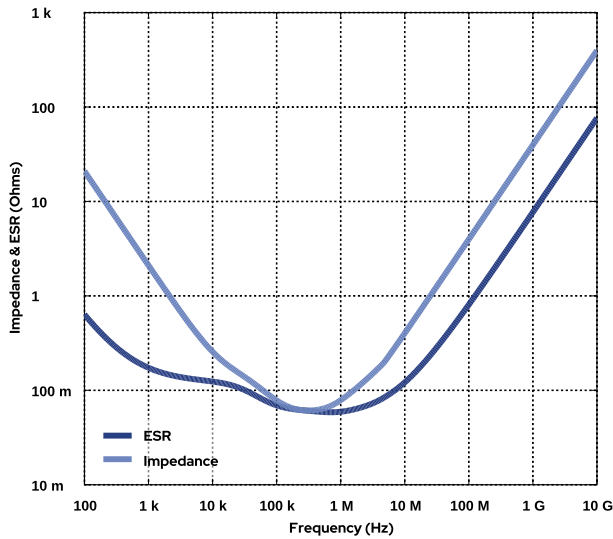
Specifications

Capacitance	75 uF
Capacitance Tolerance	10%
Voltage DC	75 VDC (85C), 49.5 VDC (125C), 86.25 VDC (85C Surge)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Humidity	40C, 60% RH
Dissipation Factor	5% 120Hz 25C
Failure Rate	N/A
Resistance	110 mOhm (100kHz 25C)
Ripple Current	1580 mAmps (40kHz 85C)
Leakage Current	42.2 uA (5min 25°C)

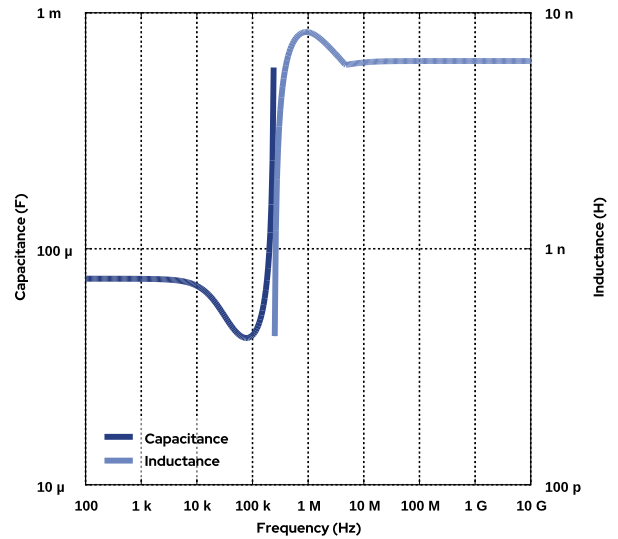
Simulations

For the complete simulation environment please visit [K-SIM](#).

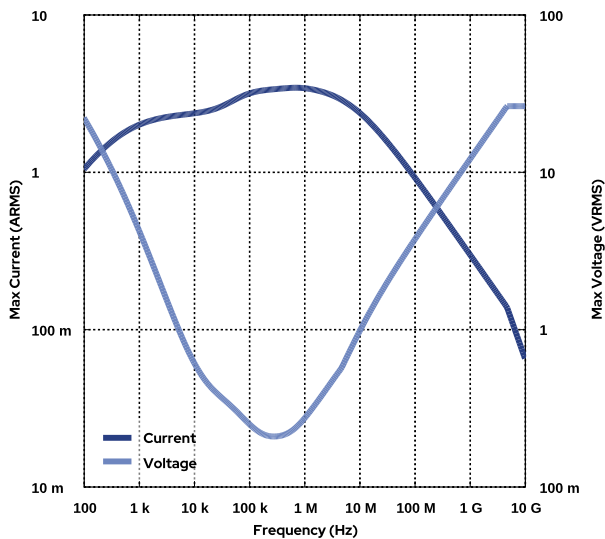
Impedance and ESR



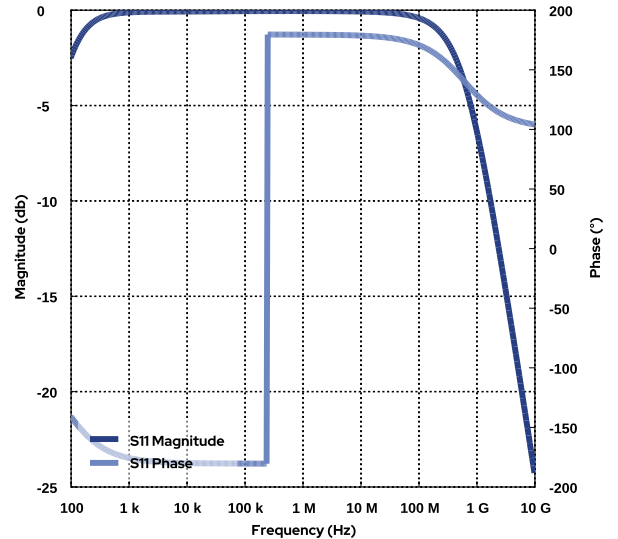
Capacitance and Inductance

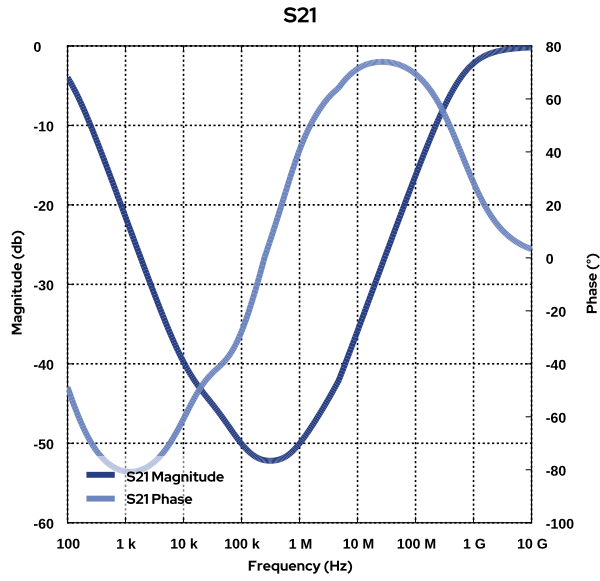


Current and Voltage



S11





These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.